

LMH0001 SMPTE 259M / 344M Serial Digital Cable Driver

General Description

The LMH0001 SMPTE 259M / 344M Serial Digital Cable Driver is designed for use in SMPTE 259M / 344M serial digital video applications. The LMH0001 drives 75 Ω transmission lines (Belden 8281, Belden 1694A or equivalent) at data rates up to 540 Mbps.

The output voltage swing of the LMH0001 is adjustable via a single external resistor.

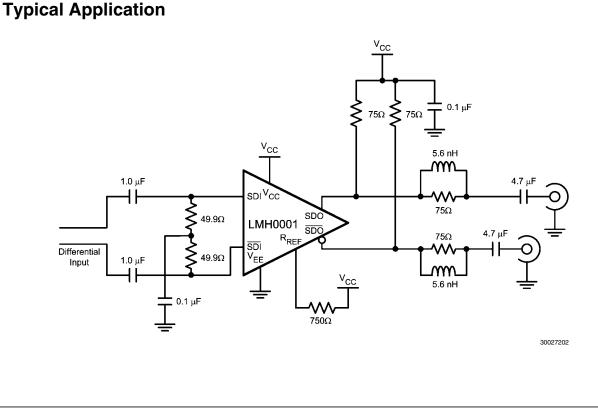
The LMH0001 is powered from a single 3.3V supply. Power consumption is typically 125mW. The LMH0001 is available in a 16-pin LLP package.

Features

- SMPTE 259M and SMPTE 344M compliant
- Data rates to 540 Mbps
- Supports DVB-ASI at 270 Mbps
- Differential input
- 75Ω differential output
- Adjustable output amplitude
- Single 3.3V supply operation
- Industrial temperature range: -40°C to +85°C
- 125mW typical power consumption
- 16-pin LLP package
- Footprint compatible with the LMH0002SQ and the GS9078A.

Applications

- SMPTE 259M and SMPTE 344M serial digital interfaces
- DVB-ASI applications
- Sonet/SDH and ATM interfaces
- Digital routers and switches
- Distribution amplifiers
- Buffer applications
- Set top boxes
- Security cameras



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Absolute Maximum Ratings (Note 1)

| | - |
|---------------------------------------|--------------------------------|
| Supply Voltage: | -0.5V to 3.6V |
| Input Voltage (all inputs) | -0.3V to V _{CC} +0.3V |
| Output Current | 28mA |
| Storage Temperature Range | -65°C to +150°C |
| Junction Temperature | +150°C |
| Lead Temperature (Soldering 4 Sec) | +260°C |
| Package Thermal Resistance | |
| θ _{JA} 16-pin LLP | +78.9°C/W |
| θ _{JC} 16-pin LLP | +42.7°C/W |
| | |

ESD Rating (HBM) ESD Rating (MM) 250V

5kV

Recommended Operating Conditions

| Supply Voltage (V _{CC} – V _{EE}): | 3.3V ±5% |
|--|----------------|
| Operating Free Air Temperature (T_A) | –40°C to +85°C |

DC Electrical Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified (Notes 2, 3).

| Symbol | Parameter | Conditions | Reference | Min | Тур | Max | Units |
|--------------------|----------------------------|---|-----------------|---------------------|---------------------------------------|---------------------|-------------------|
| V _{CMIN} | Input Common Mode Voltage | | SDI, <u>SDI</u> | 1.6 + | | V _{CC} – | v |
| | | | | V _{SDI} /2 | | V _{SDI} /2 | v |
| V _{SDI} | Input Voltage Swing | Differential | | 100 | | 2000 | mV _{P-P} |
| V _{CMOUT} | Output Common Mode Voltage | | SDO, SDO | | V _{CC} – V _{SDO} | | V |
| V_{SDO} | Output Voltage Swing | Single-ended, 75 Ω load, R _{REF} = 750 Ω 1% | | 750 | 800 | 850 | mV _{P-P} |
| | | Single-ended, 75Ω load, R _{REF} = 590 Ω 1% | | 900 | 1000 | 1100 | mV _{P-P} |
| I _{CC} | Supply Current | (Note 5) | | | 38 | 43 | mA |

AC Electrical Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified (Note 3).

| Symbol | Parameter | Conditions | Reference | Min | Тур | Max | Units |
|--------------------------------|-----------------------------|------------|-----------|-----|-----|-----|-------------------|
| DR _{SDI} | Input Data Rate | (Note 4) | SDI, SDI | | | 540 | Mbps |
| t _{jit} | Additive Jitter | 270 Mbps | SDO, SDO | | 18 | | ps _{P-P} |
| t _r ,t _f | Output Rise Time, Fall Time | 20% - 80% | | 400 | 560 | 800 | ps |
| | Mismatch in Rise/Fall Time | (Note 4) | | | | 30 | ps |
| | Duty Cycle Distortion | (Note 4) | | | | 100 | ps |
| t _{os} | Output Overshoot | (Note 4) | | | | 8 | % |
| RL _{SDO} | Output Return Loss | (Note 6) | | 15 | 20 | | dB |

Note 1: "Absolute Maximum Ratings" are those parameter values beyond which the life and operation of the device cannot be guaranteed. The stating herein of these maximums shall not be construed to imply that the device can or should be operated at or beyond these values. The table of "Electrical Characteristics" specifies acceptable device operating conditions.

Note 2: Current flow into device pins is defined as positive. Current flow out of device pins is defined as negative. All voltages are stated referenced to V_{FF} = 0 Volts.

Note 3: Typical values are stated for V_{CC} = +3.3V and T_A = +25°C.

Note 4: Specification is guaranteed by characterization.

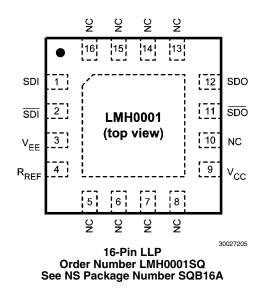
Note 5: Maximum I_{CC} is measured at V_{CC} = +3.465V and T_A = +70°C.

Note 6: Output return loss is dependent on board design. The LMH0001 meets this specification on the SD001SQ evaluation board from 5MHz to 1.5GHz.

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LMH0001

Connection Diagram



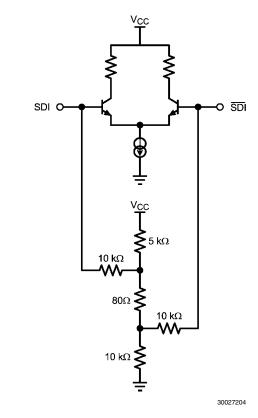
Pin Descriptions

| SOIC Pin # | LLP Pin # | Name | Description |
|---------------|--------------|------------------|---|
| 1 | 1 | SDI | Serial data true input. |
| 2 | 2 | SDI | Serial data complement input. |
| 3 | 3 | V _{EE} | Negative power supply (ground). |
| 4 | 4 | R _{REF} | Output driver level control. Connect a resistor to V _{CC} to set output voltage swing. |
| 5 | 9 | V _{cc} | Positive power supply (+3.3V). |
| 7 | 11 | SDO | Serial data complement output. |
| 8 | 12 | SDO | Serial data true output. |
| _ | 5, 6, 7, 8, | NC | No connect. |
| | 10, 13, 14, | | |
| | 15, 16 | | |
| _ | DAP | V _{EE} | Connect exposed DAP to negative power supply (ground). |

Device Operation

INPUT INTERFACING

The LMH0001 accepts either differential or single-ended input. The inputs are self-biased, allowing for simple AC or DC coupling. DC-coupled inputs must be kept within the specified common-mode range. SDI and \overline{SDI} are self-biased at approximately 2.1V with V_{CC} = 3.3V. *Figure 1* shows the differential input stage for SDI and \overline{SDI} .

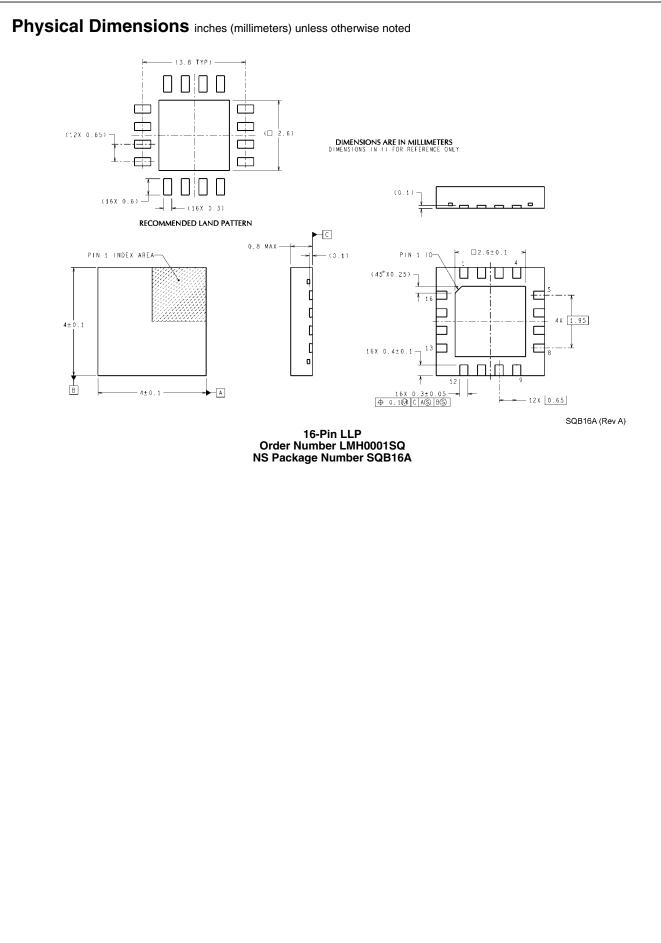




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OUTPUT INTERFACING

The LMH0001 uses current mode outputs. Single-ended output levels are 800 mV_{P-P} into 75 Ω AC-coupled coaxial cable (with R_{REF} = 750 Ω). Output level is controlled by the value of the R_{REF} resistor connected between the R_{REF} pin and V_{CC}. The R_{REF} resistor should be placed as close as possible to the R_{REF} pin. In addition, the copper in the plane layers below the R_{REF} network should be removed to minimize parasitic capacitance.



LMH0001

Notes

| Pr | oducts | Design Support | | |
|--------------------------------|------------------------------|-------------------------|--------------------------------|--|
| Amplifiers | www.national.com/amplifiers | WEBENCH | www.national.com/webench | |
| Audio | www.national.com/audio | Analog University | www.national.com/AU | |
| Clock Conditioners | www.national.com/timing | App Notes | www.national.com/appnotes | |
| Data Converters | www.national.com/adc | Distributors | www.national.com/contacts | |
| Displays | www.national.com/displays | Green Compliance | www.national.com/quality/green | |
| Ethernet | www.national.com/ethernet | Packaging | www.national.com/packaging | |
| Interface | www.national.com/interface | Quality and Reliability | www.national.com/quality | |
| LVDS | www.national.com/lvds | Reference Designs | www.national.com/refdesigns | |
| Power Management | www.national.com/power | Feedback | www.national.com/feedback | |
| Switching Regulators | www.national.com/switchers | | | |
| LDOs | www.national.com/ldo | | | |
| LED Lighting | www.national.com/led | | | |
| PowerWise | www.national.com/powerwise | | | |
| Serial Digital Interface (SDI) | www.national.com/sdi | | | |
| Temperature Sensors | www.national.com/tempsensors | | | |
| Wireless (PLL/VCO) | www.national.com/wireless | | | |

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